PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
G. GLENN HENRY	10/22/2015
TERRY PARKS	10/22/2015
KYLE T. O'BRIEN	10/22/2015

RECEIVING PARTY DATA

Name:	VIA ALLIANCE SEMICONDUCTOR CO., LTD	
Street Address:	ROOM 301, NO.2537, JINKE ROAD	
Internal Address:	ZHANGJIANG HI-TECH PARK	
City:	SHANGHAI	
State/Country:	CHINA	
Postal Code:	201203	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14883090

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	VAS.3037	
NAME OF SUBMITTER:	TAYSIE J. LOCKE	
SIGNATURE:	/Taysie J. Locke/	
DATE SIGNED: 12/29/2015		
	This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 2

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PATENT REEL: 037372 FRAME: 0858

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PATENT REEL: 037372 FRAME: 0859 Docket: VAS.3037 Declaration and Assignment

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

TITLE OF INVENTION HARDWARE DATA COMPRESSOR THAT SORTS HASH CHAINS BASED ON NODE STRING MATCH PROBABILITIES
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L **** T *** T *** L BASED ON NODE STRING MATCH PROBABILITIES

This is a combined declaration and assignment by the inventor(s) named below to the assignee named below.

I. Declaration and Related Statements

As a below named inventor, I hereby declare that:
This declaration is directed to:
The attached application; or
United States application or PCT International application number14883090
filed on10/14/2015
The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

II. Assignment

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on even date herewith;

AND WHEREAS, VIA Alliance Semiconductor Co., Ltd. together with any successors, legal representatives, or assigns thereof, with its principal office at Room 301, No.2537, Jinke Road Zhangjiang Hi-Tech Park Shanghai, 201203 CHINA, wants to acquire the entire right, title and interest in and to the said invention(s), and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I have sold, assigned, transferred and set over, and do hereby sell, assign, transfer and set over to the said VIA Alliance Semiconductor Co., Ltd., its successors and assigns, the entire right, title and interest in and to the said invention and in and to the said application and all patents which may be granted thereon, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I/we hereby authorize and request the Commissioner of Patents, and any officials of foreign countries whose duty it is to issue patents on applications, to issue all patents for said invention, or patents resulting therefrom, insofar as my interest in concerned, to the said VIA Alliance Semiconductor Co., Ltd. as assignee of my entire right, title and interest;

I ALSO HEREBY sell and assign to VIA Alliance Semiconductor Co., Ltd., its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent

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Declaration and Assignment

Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights;

AND I HEREBY covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith;

AND I HEREBY further covenant that I will communicate to said VIA Alliance Semiconductor Co., Ltd., or to its successors, assigns and legal representatives, any facts known to me respecting said invention, and at the expense of said VIA Alliance Semiconductor Co., Ltd., testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said VIA Alliance Semiconductor Co., Ltd., its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

III. Signatures

A. Inventors

Signature:	Date: 10/22/2015
G. Glenn Henry	
Signature: Very lank	Date: 10/22/2015
TERRY PARKS	
Signature:	Date: 10/22/2015
KYLE T. O'BRIEN	

Huffman Law Group, P.C. Attorneys at Law Customer No. 23669 7702 Barnes Rd., Ste 140-46 Colorado Springs CO 80922

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